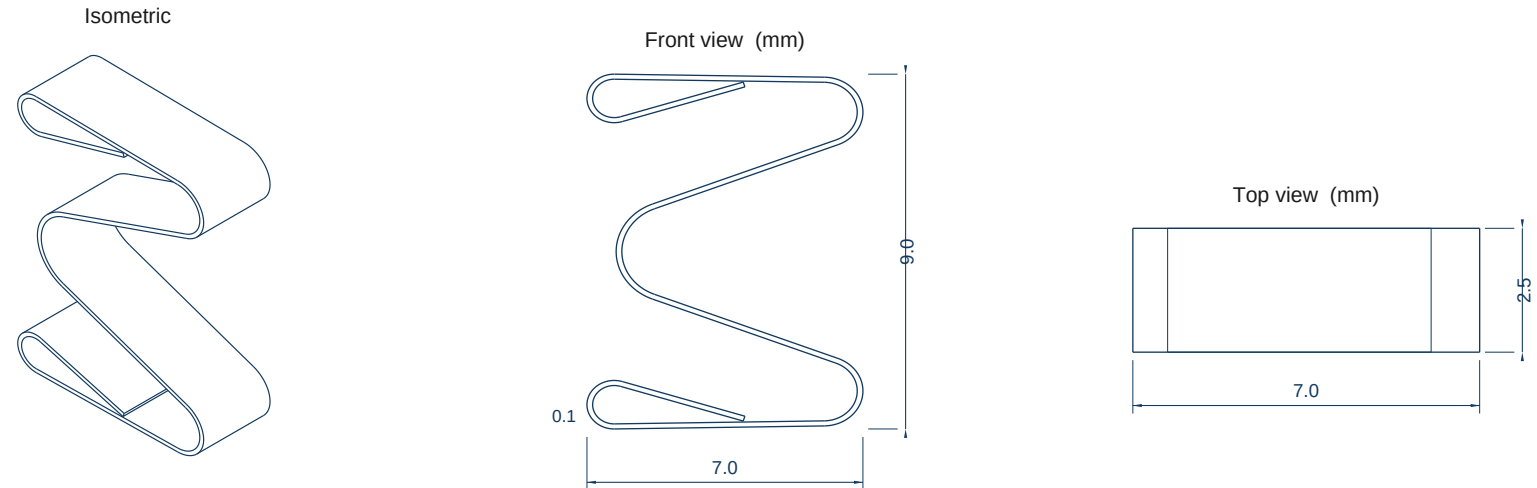




Type 3-01 B301-25070090

SMD EMI Spring Contact | Beryllium Copper | Units: mm



MECHANICAL

VALUE

Thickness	0.10 mm
Width	2.5 mm +/- 0.2
Length	7.0 mm +/- 0.2
Height	9.0 mm +/- 0.2
Form	Z-serpentine: 2 folded hems, 3 curls, mirror-symmetric
Profile source	scaled from B3-25048070, x1.443 (L) / x1.286 (H) - see note
Material / plating	BeCu, Gold-plated (G)
Volume / mass	12.804 mm ³ 106.9 mg (BeCu)
File format	STEP AP214

PRODUCT DATA

VALUE

Mfr P/N	B301-25070090G-SY (Au)
Brand	Seyunda
Description	SMD EMI Contact 7.0x2.5x9.0mm Au
Packaging	Tape & Reel (TR)
Category	Connectors, Interconnects
Sub-category	Contacts, Spring Loaded (Pogo Pins), and Pressure
Lifecycle / origin	Active / Taiwan, Republic of China
RoHS / REACH	RoHS3 Compliant / REACH Unaffected
ECCN / ESD	EAR99 / Static sensitive: Yes
Datasheet	seyunda.com/datasheet/Seyunda-SMD-Spring-Contacts-Datasheet.pdf
Product page	seyunda.com/type-3-01.html